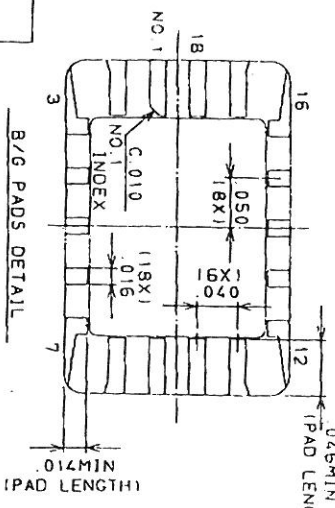
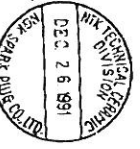


- NOTES:
1. GOLD PLATE 50, INCHES MIN OVER 80, INCHES MIN NICKEL.
  2. NO LEAD TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD. SEAL RING ISOLATED.
  3. NOTCH METALLIZATION TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD.



3	RING	KOVAR		
2	LEAD	ALLOY 42		
1	CERAMIC	ALUMINA		
DRAFTSMAN: M. L. T. 1 CHECKED: K.F. APPROVED: [Signature] DATE: DEC-24-1991 TITLE: NEW DRAWING PART NO: 18LD 5/B PACKAGE SHEET OF: M-H				